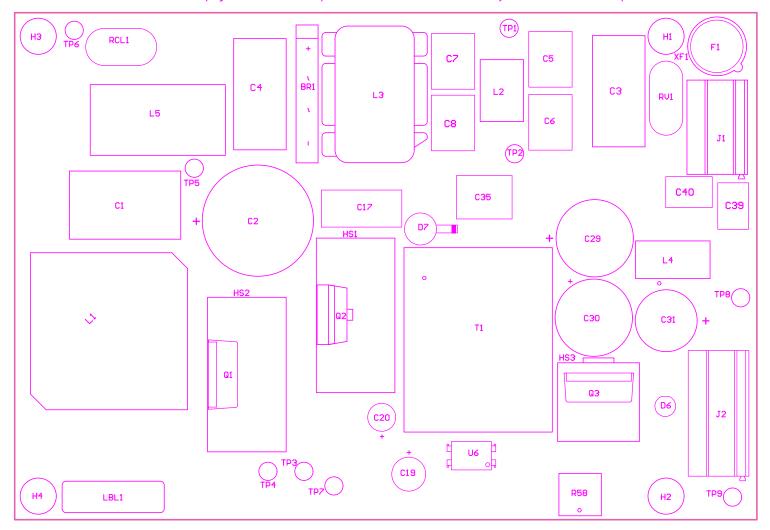
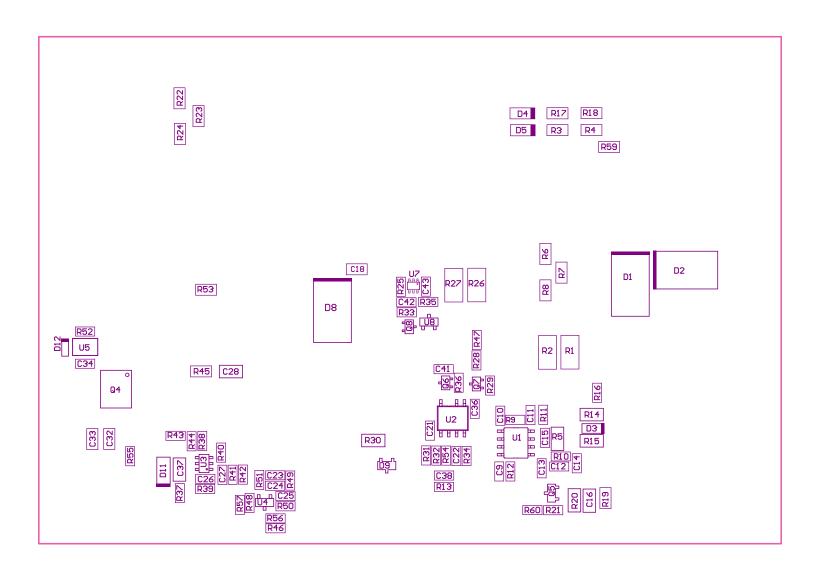
- ZZ1 ■Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- ZZ2 These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00701	REV: RevB	SUN REV:	: Not In VersionControl
IGNORE -> M5 Assembly Top				
PLOT NAME = Top Assembly Drawing	GENERATED : 11/24/	2015 3:15:26	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00701	REV: RevB	SVN REV: Not In VersionControl	
	IGNORE -> M6 Assembly Bottom			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 11/24/	2015 3:15:27	PM TEXAS INSTRUMENTS	

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